

UNISONIC TECHNOLOGIES CO., LTD

UT4232

Preliminary

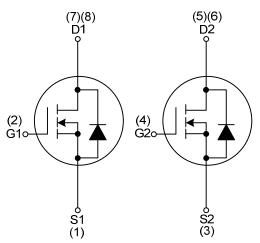
N-CHANNEL ENHANCEMENT MODE POWER MOSFET

DESCRIPTION

The **UT4232** uses UTC advanced technology to provide excellent $R_{DS(ON)}$, low gate charge and to be operated with low gate voltages. This device is suitable for applications, such as high-side DC/DC conversion, notebook and sever.

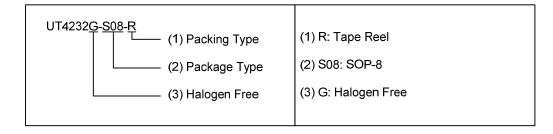
FEATURES

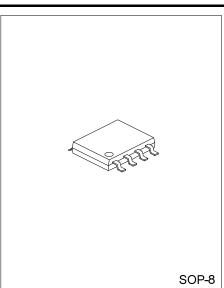
- * V_{DS}(V)=30V
- * I_D=7A (V_{GS} = 10V)
- * $R_{DS(ON)} < 22m\Omega@V_{GS} = 10V$
- * R_{DS(ON)}<32mΩ@V_{GS}=4.5V
- * Halogen Free
- SYMBOL



ORDERING INFORMATION

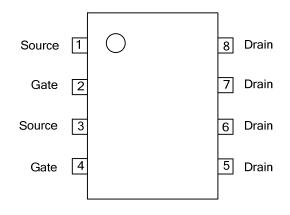
Ordering Number	Package	Packing
UT4232G-S08-R	SOP-8	Tape Reel





UT4232

PIN CONFIGURATION





ABSOLUTE MAXIMUM RATINGS

PARAMETER	SYMBOL	RATINGS	UNIT
Drain-Source Voltage	V _{DSS}	30	V
Gate-Source Voltage	V _{GSS}	±20	V
Continuous Drain Current (Ta=25°C)(Note 2)	I _D	7.8	А
Pulsed Drain Current (Note 3)	I _{DM} 30		А
Power Dissipation (Ta=25°C)	D	2	W
Derate above Ta>25°C	PD	0.016	W/°C
Junction Temperature	TJ	+150	°C
Junction and Storage Temperature Range	T _{STG}	-55 ~ +150	°C

Note: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged. Absolute maximum ratings are stress ratings only and functional device operation is not implied.

2. Surface mounted on 1 in² copper pad of FR4 board, t≤10sec; 135°C/W when mounted on min

3. Pulse width limited by $T_{J(MAX)}$

THERMAL DATA

PARAMETER	SYMBOL	MIN	TYP	MAX	UNIT
Junction to Ambient	θ _{JA}		62.5		°C/W

Note: Surface mounted on 1 in² copper pad of FR4 board, t≤10sec; 135°C/W when mounted on min

■ ELECTRICAL CHARACTERISTICS (T_J = 25°C, unless otherwise specified)

PARAMETER	SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT		
OFF CHARACTERISTICS								
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0 V, I _D =250 μA	30			V		
Breakdown Voltage Temperature Coefficient	$\Delta BV_{DSS}/\Delta T_{J}$	Reference to 25°C,I _D =1mA		0.02		V/°C		
Drain-Source Leakage Current	I _{DSS}	V _{DS} =30 V,V _{GS} =0 V			1	μA		
Gate-Source Leakage Current	I _{GSS}	V_{GS} =±20 V, V_{DS} =0 V			±100	nA		
ON CHARACTERISTICS								
Gate Threshold Voltage	V _{GS(TH)}	V _{D S} = V _{GS} , I _D =250 μA	1		3	V		
Drain-Source On-State Resistance	R _{DS(ON)}	V _{GS} =10 V, I _D =7 A			22	mΩ		
		V _{GS} =4.5 V, I _D =5 A			32	mΩ		
DYNAMIC PARAMETERS								
Input Capacitance	C _{ISS}			720	1150	рF		
Output Capacitance	C _{OSS}	V _{DS} =25V, V _{GS} =0 V, f=1MHz		230		рF		
Reverse Transfer Capacitance	C _{RSS}			200		pF		
SWITCHING PARAMETERS								
Turn-ON Delay Time	t _{D(ON)}			10		ns		
Turn-ON Rise Time	t _R	V_{GS} =10V, V_{DS} =15V, R _D =15 Ω ,		7		ns		
Turn-OFF Delay Time	t _{D(OFF)}	R _G =3.3Ω, I _D =1 A		22		ns		
Turn-OFF Fall-Time	t _F			8		ns		
Total Gate Charge	Q _G	V _{GS} =4.5 V, V _{DS} =24 V, I _D =7 A		13	21	nC		
Gate Source Charge	Q _{GS}			3		nC		
Gate Drain Charge	Q _{GD}			9		nC		
SOURCE- DRAIN DIODE RATINGS AND CHARACTERISTICS								
Drain-Source Diode Forward Voltage	V _{SD}	I _S =1.7 A, V _{GS} =0 V			1.2	V		
Reverse Recovery Time	t _{RR}	Is=7 A. V _{GS} =0 V. dl/dt=100A/us		16		ns		
Reverse Recovery Charge	Q _{RR}	$15-7$ A, $v_{GS}=0$ V, $u/u_{L}=100$ A/ μ S		8		nC		



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